Fig.1

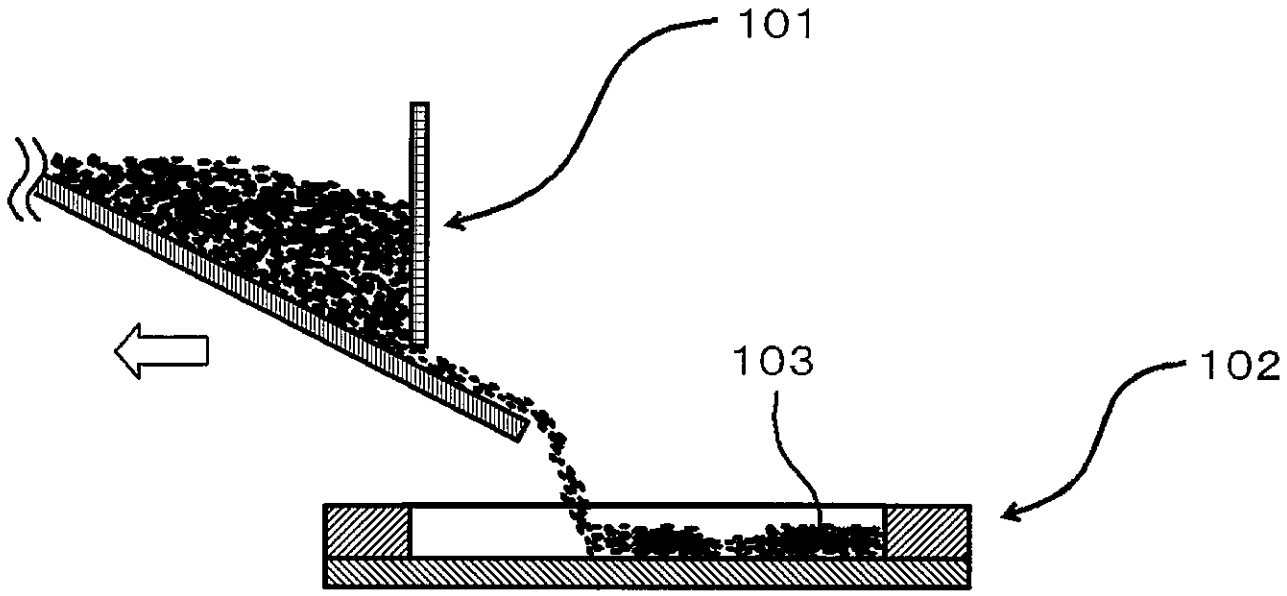
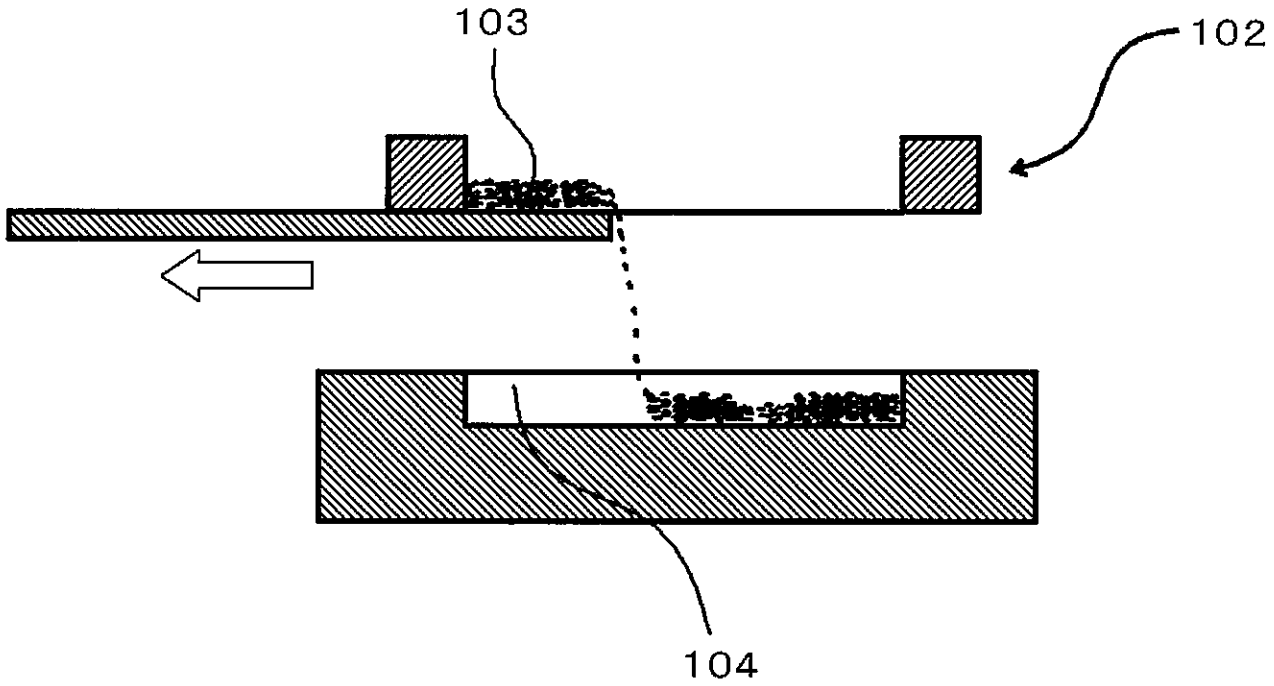


Fig.2



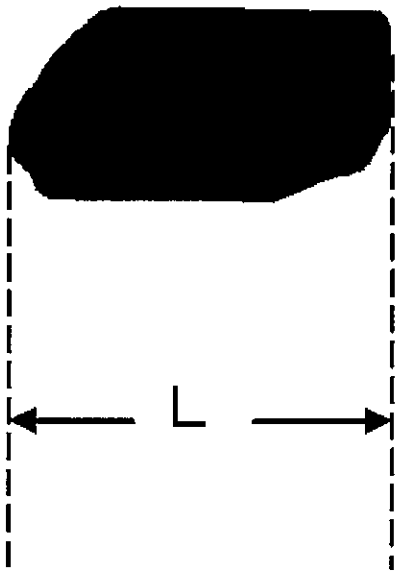


Fig. 3 (A) LONGEST LENGTH (L)

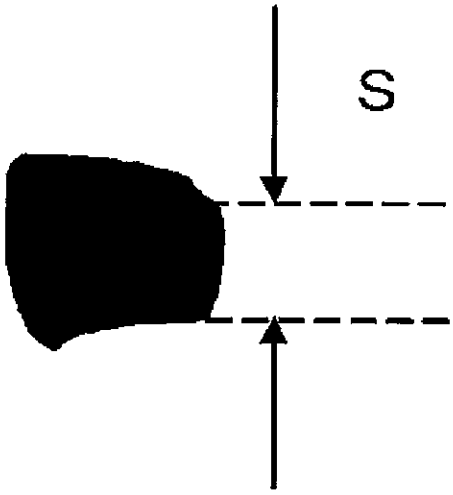


Fig. 3 (B) SHORTEST LENGTH (S)

Fig.4

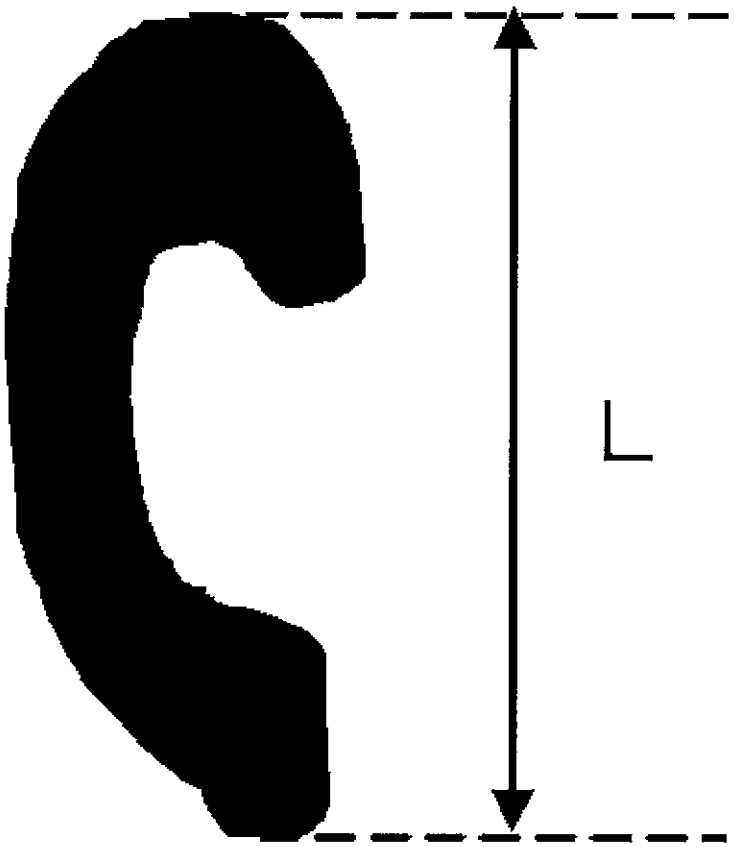


Fig.5

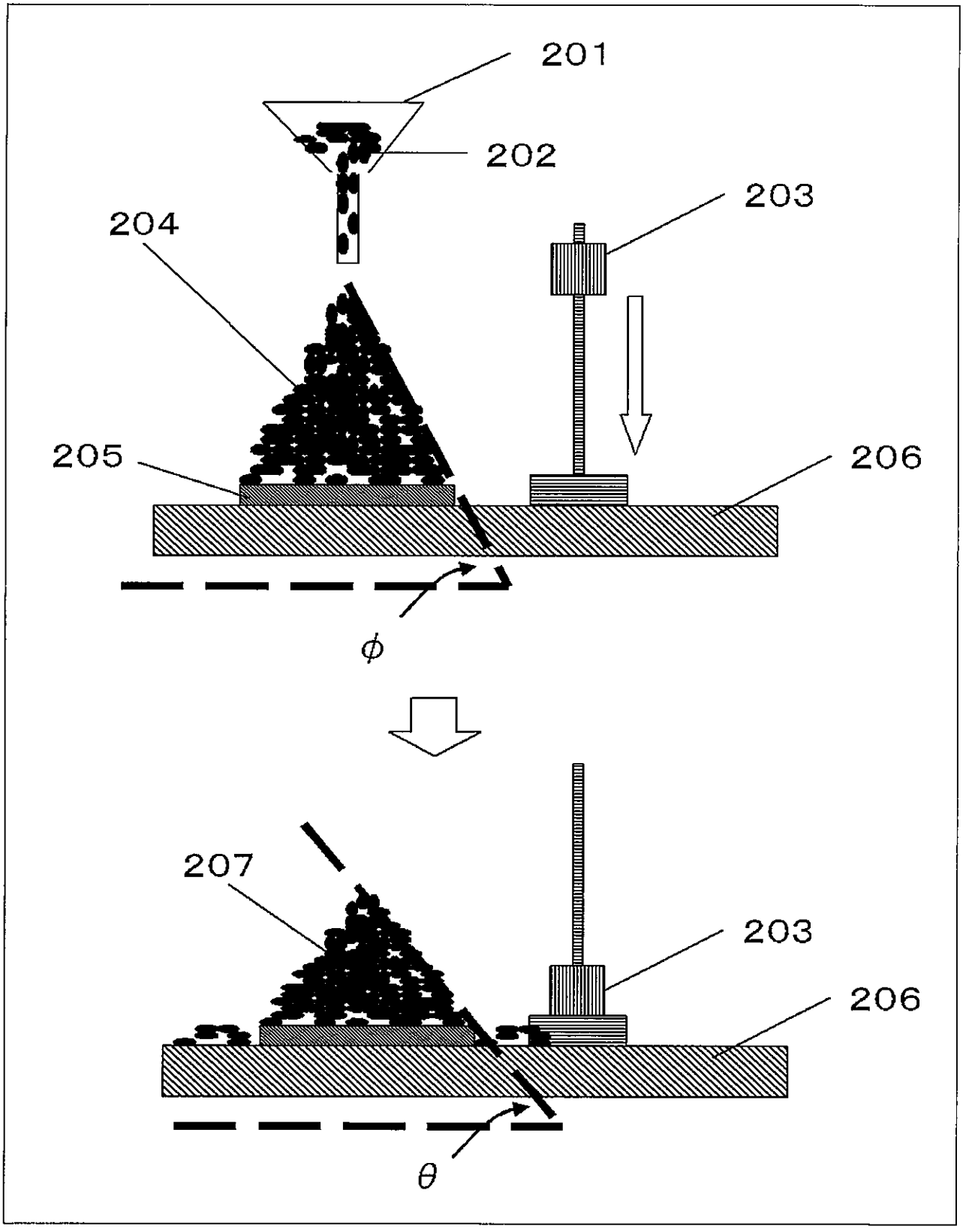


Fig.6

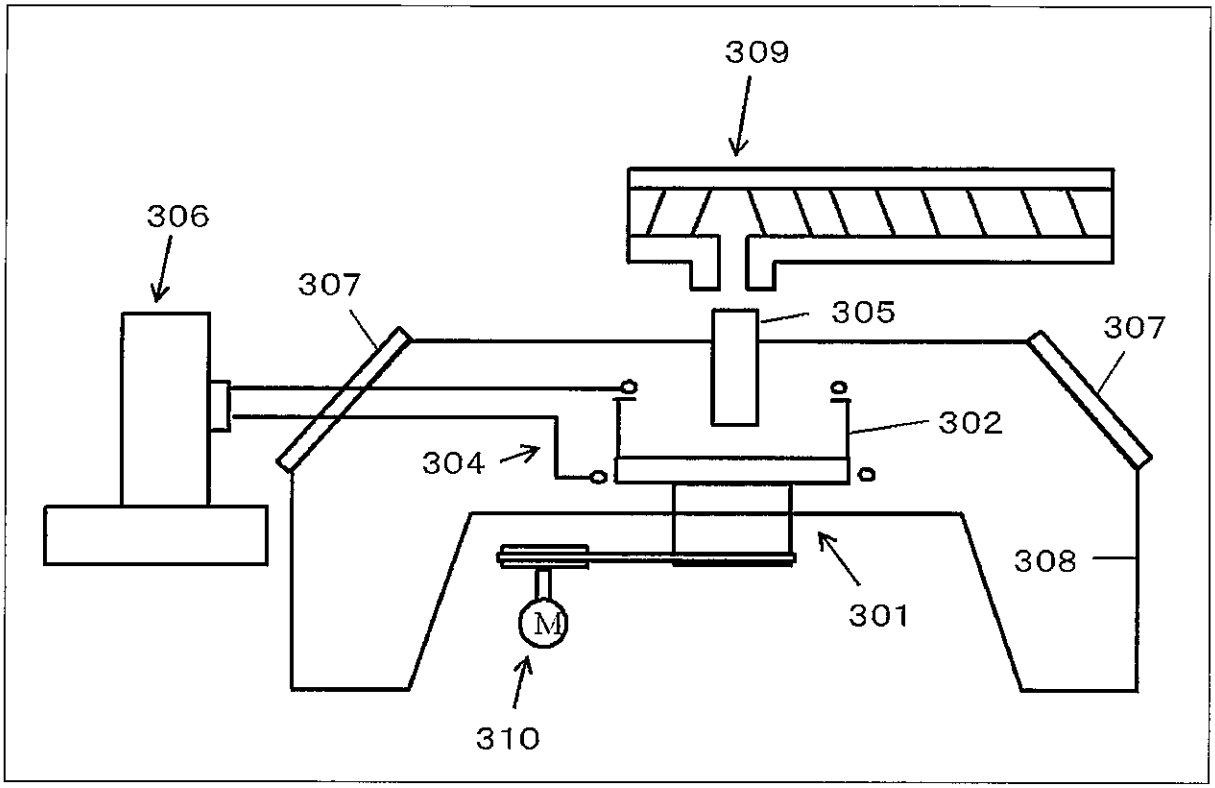


Fig.7

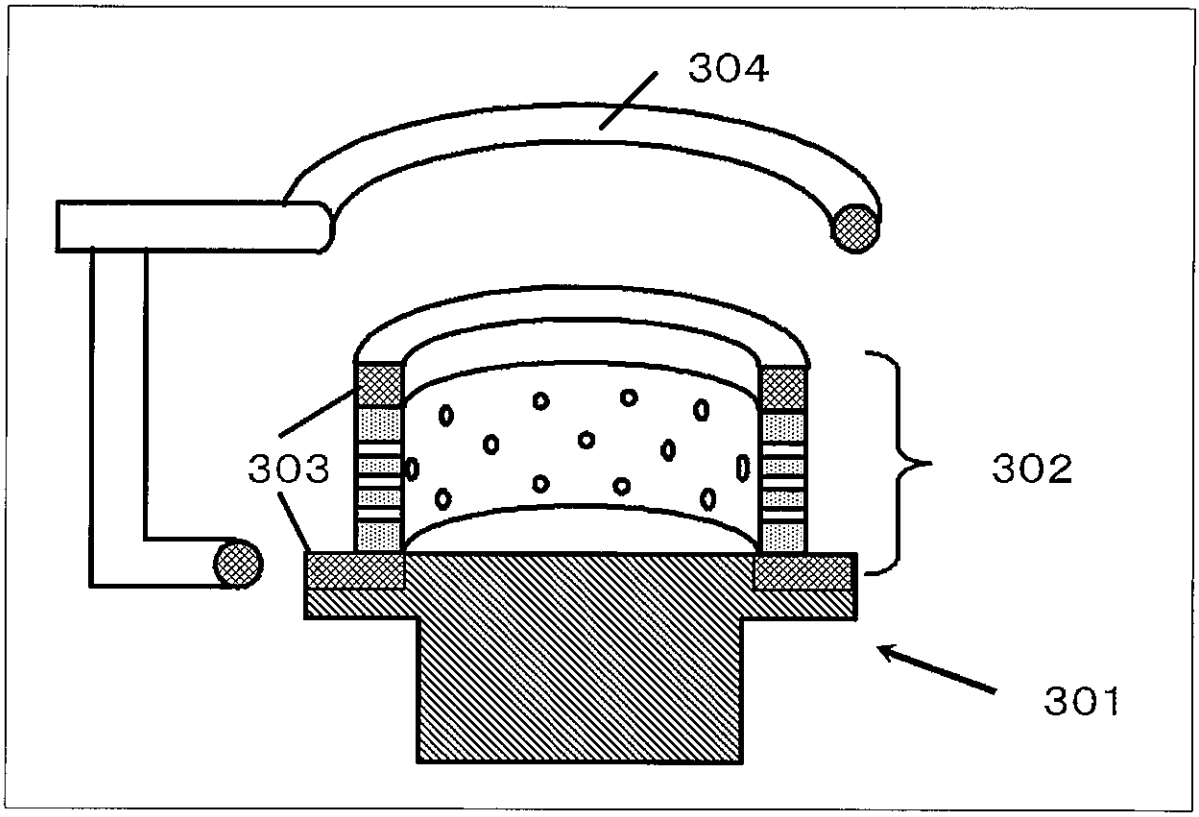


Fig.8

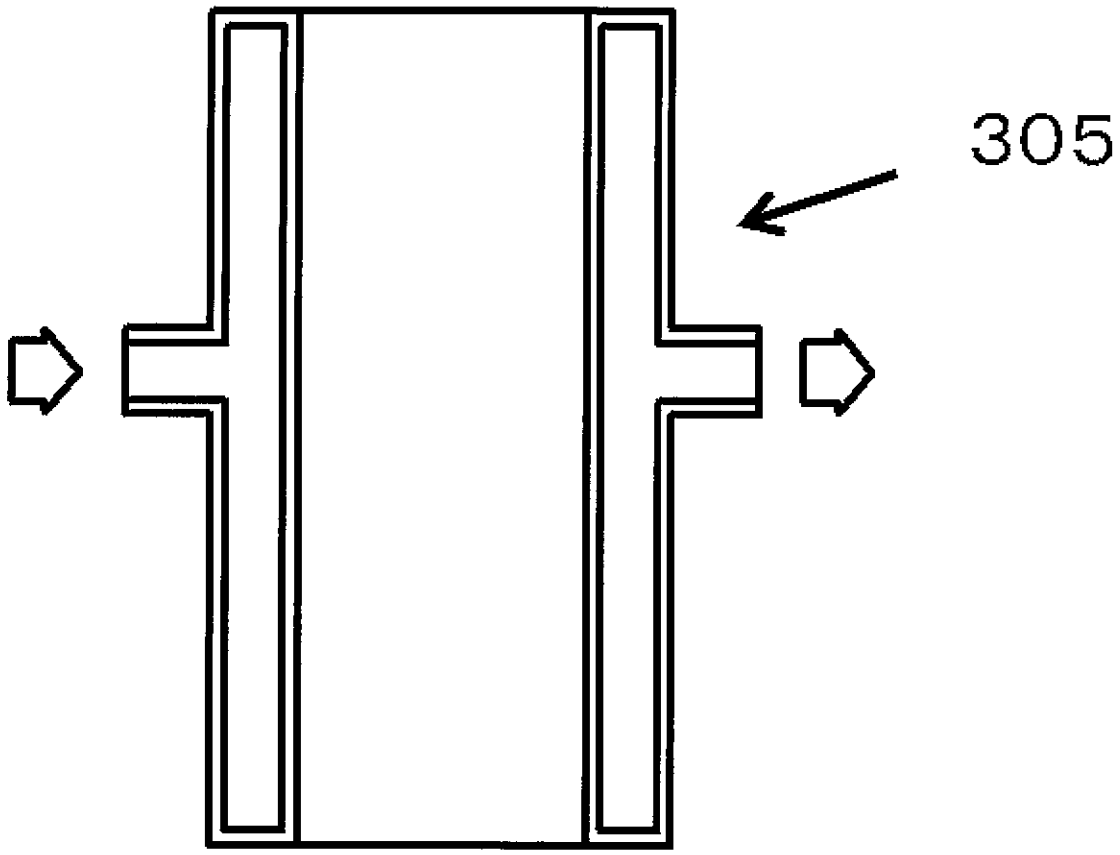


Fig.9

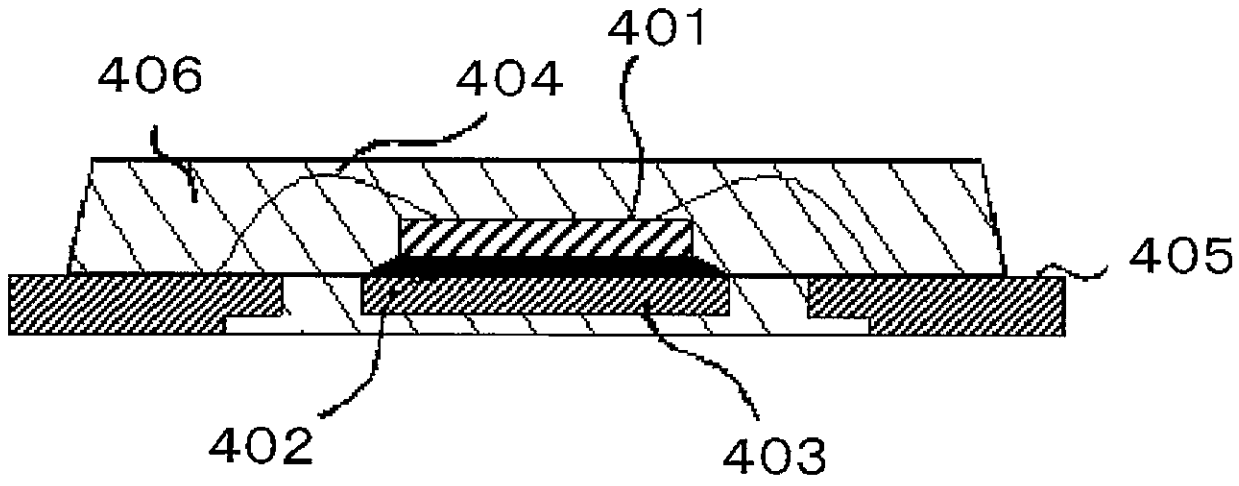


Fig.10

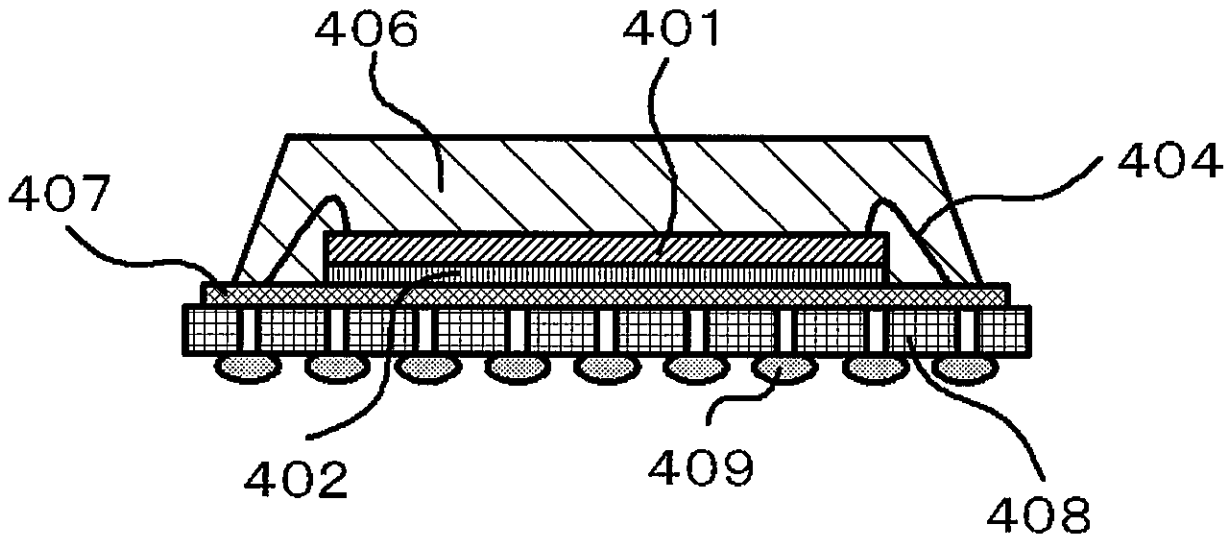


Fig.11

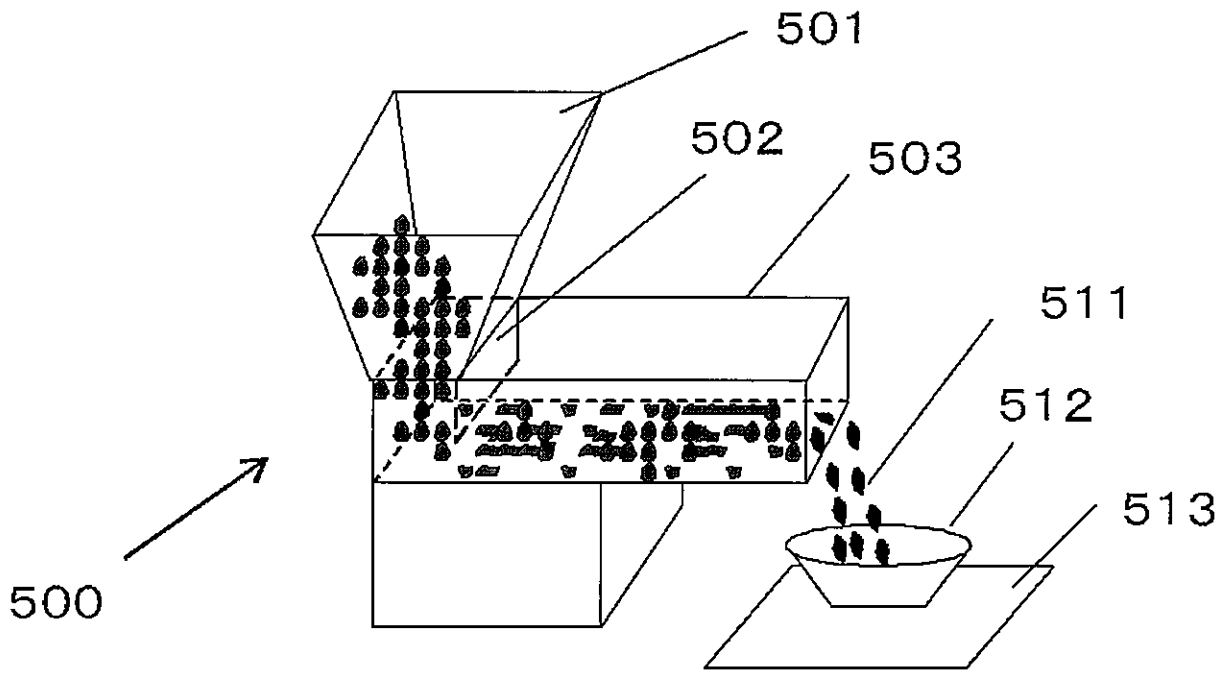


Fig.12

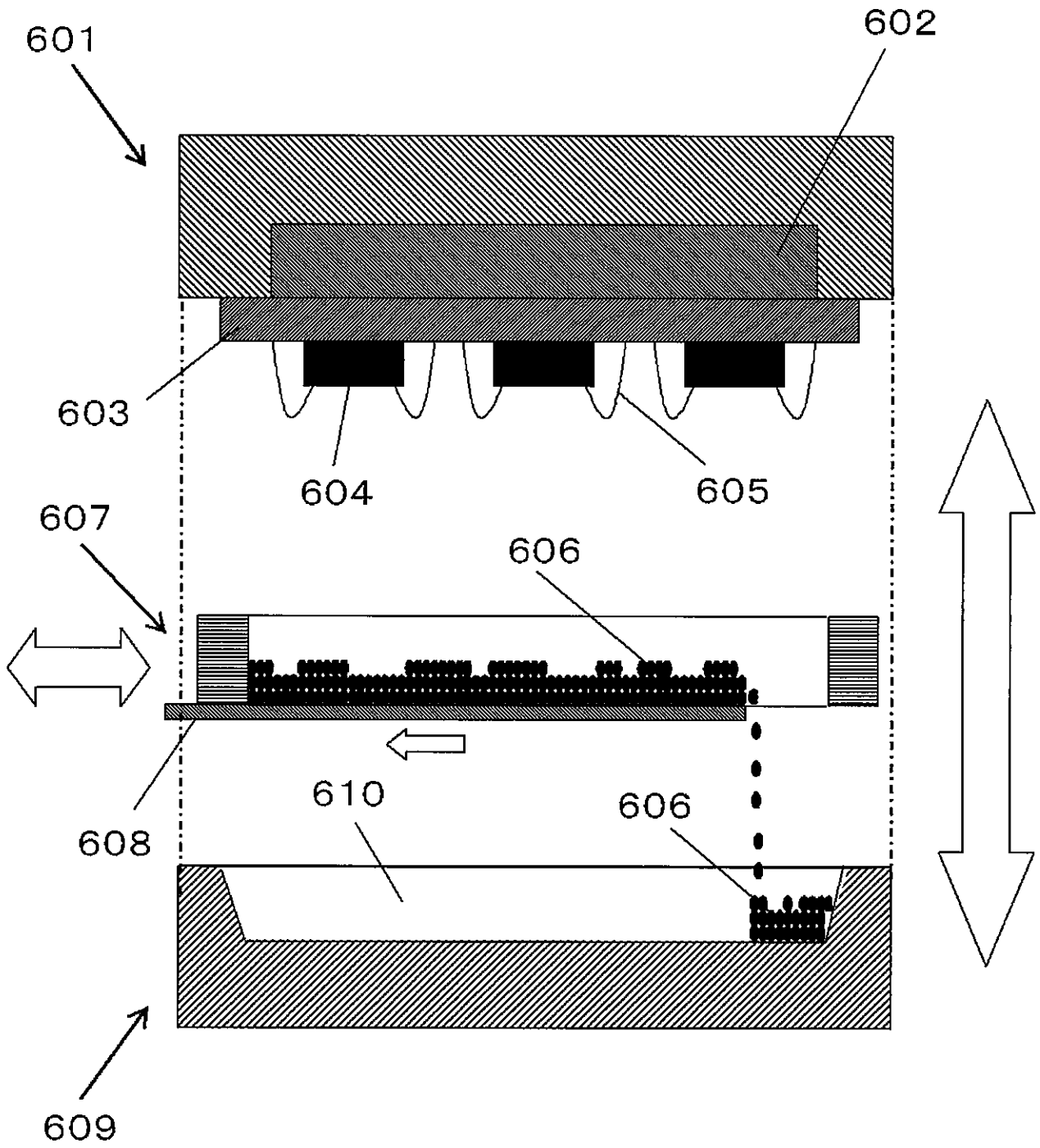


Fig.13

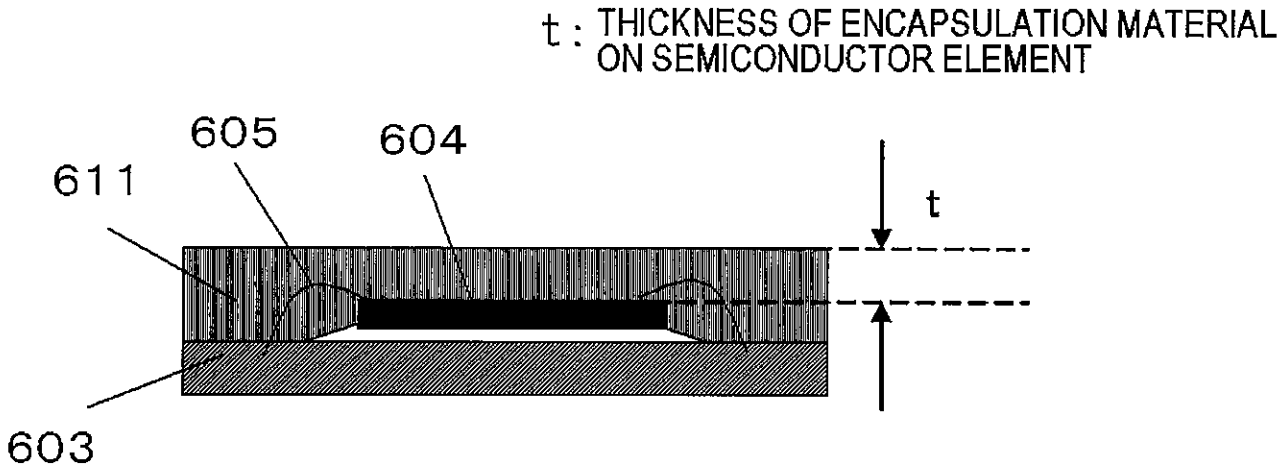
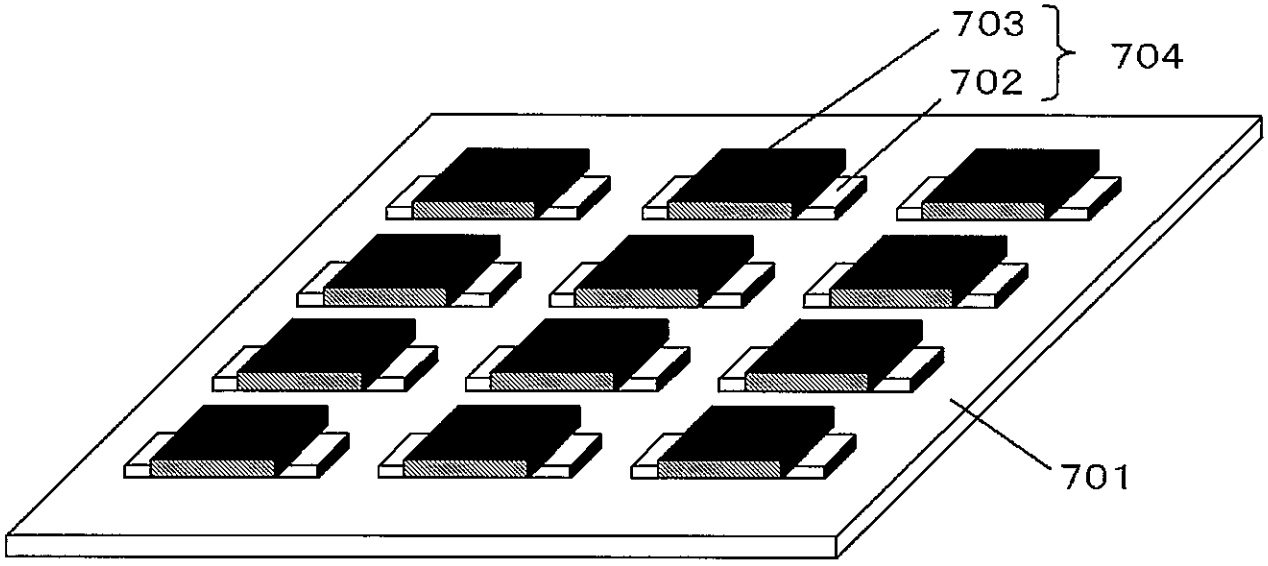

t : THICKNESS OF ENCAPSULATION MATERIAL ON SEMICONDUCTOR ELEMENT
605
604
611
t
603

Fig.14


703
702
704
701